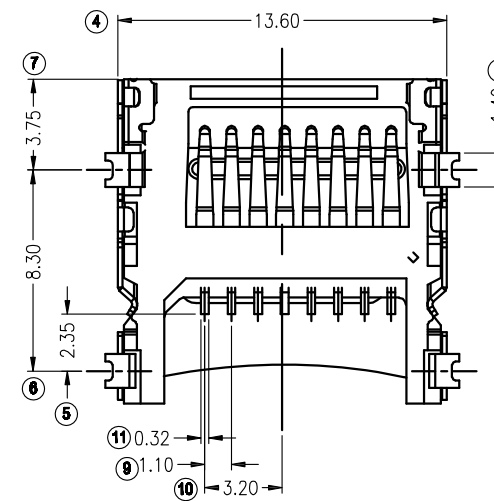
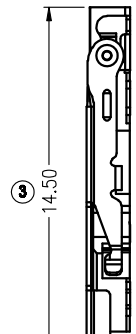
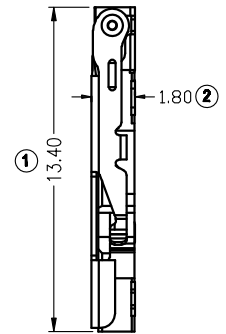
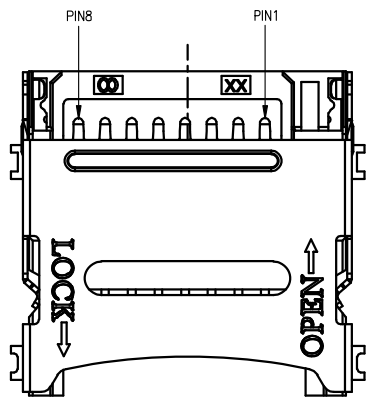


REV.	ECN.NO.	APPD.
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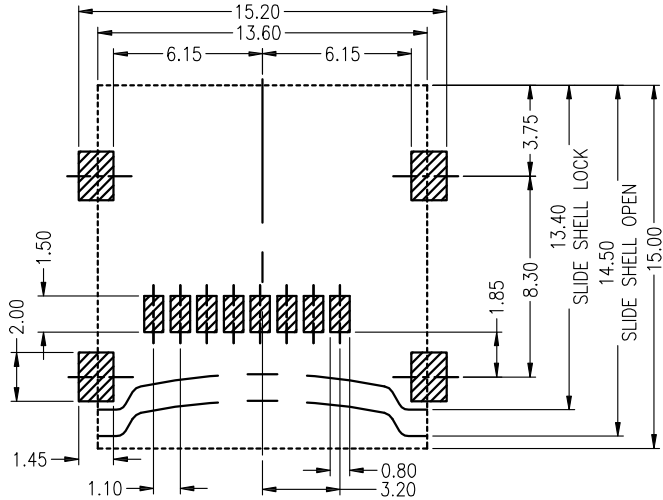
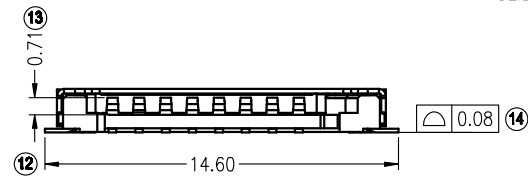
**\*Electrical Characteristics:**  
 Contact Current Rating:0.5 Amperes.  
 Dielectric Withstanding Voltage:AC500V r.m.s.  
 Insulation Resistance:1000 MΩ Minimum.  
 Contact Resistance:100 mΩ Maximum.

**\*Environmental:**  
 Operating Temperature:-25°C~+90°C.

**\*Environmental:**  
 Mating Cycles:5000~10,000 Insertions.

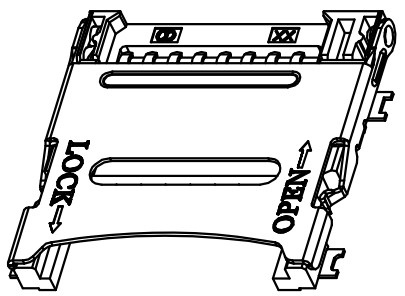
**\*Mechanical Characteristics:**  
 Card Push Insertion/Out Force:1.4kgf. MAX  
 Contact Separation Force:0.20kgf Minimum.

**\*Material:**  
 Insulator:HI-Temp Plastic UL 94V-0 Rated.  
 Contact:Copper Alloy(t=0.15mm).  
 Shell:Stainless Steel(t=0.20mm).  
 Spring:SWP.



**RECOMMENDED PCB LAYOUT**

--- 产品外形    ▨ 焊盘



SD5209-13B-G618

B: 不锈钢镀镍    1: 吸塑盒  
 G: 半金G/Fu"    6: LCP黑色

TOLERANCE UNLESS OTHERWISE SPECIFIED		<b>FLW</b> 深圳市华联威电子科技有限公司				
.XXX ±0.10 .XX ±0.20 .X ±0.30		HUA LIAN WEI TECHNOLOGY ELECTRONICS CO.;LTD.				
APPROVED		PART NAME:	TF 卡座 掀盖式8P高度1.8			
CHECKED		PART No:	SD5209-13B-G618	C		
DRAWN	chenyiting	PROJECTION:	UNIT:	SCALE	SHEET	REV.
DATE	2023.04.18		mm	1:1	10F1	A